SN54136, SN54LS136, SN74136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES WITH OPEN-COLLECTOR OUTPUTS

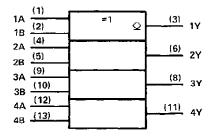
DECEMBER 1972 - REVISED MARCH 1988

FI	IN	CT	.,	١٨I	т.	ΛÞ	1 6

INP	UTS	OUTPUT
Α	8	Y
L	L	L
L	н	н
Н	L	н
Н	н	L

H = high level, L = low level

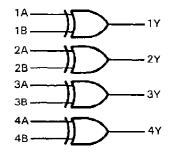
logic symbol†



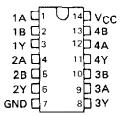
[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

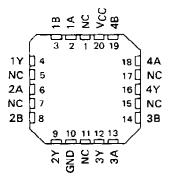
logic diagram (each gate)



SN54136, SN54LS136...J OR W PACKAGE SN74136...N PACKAGE SN74LS136...D OR N PACKAGE (TOP VIEW)



SN54LS136 . . . FK PACKAGE (TOP VIEW)

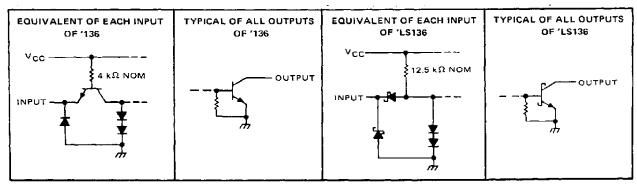


NC - No internal connection

positive logic

$$Y = A \oplus B = \overline{A} \cdot B + A \cdot \overline{B}$$

schematics of inputs and outputs



Resistor values shown are nominal.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard werranty. Production processing does not necessarily include tasting of all parameters.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .								٠							7 '	٧
Input voltage																
Operating free-air temperature range:	SN54136											-55	5°C	to	125°	C
	SN74136												00	C to	o 70°	С
Storage temperature range															150°	

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5413	6		UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	0,411
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧
High-level input voltage, VIH	2			2			V
Low-level input voltage, VIL			Q.B			0.8	V
High-level output voltage, VOH			5.5			5.5	V
Low-level output current, IOL			16	1		16	mA
Operating free-air temperature, TA	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	R TEST CONDITIONS			SN5413	6	;	UNIT				
PANAIVIETEN		TEST CONDITIONS			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	l ₁ = -8 mA					- 1.5			- 1.5	V
lou	$V_{CC} = MIN,$	V1H = 2 V,	$V_{\rm IL} = 0.8 \rm V_{\rm c}$	V _{OH} = 5.5 V						0.25	mΑ
loн	$V_{CC} = MIN,$	V _{IH} = 2 V.	$V_{\rm IL} = 0.7 \rm V_{\rm c}$	V _{OH} = 5.5 V			0.25				ША
VOL	$V_{CC} = MIN,$	$V_{1H} = 2 V_{i}$	$V_{\rm IL} = 0.8 \rm V$,	1 _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
l _l	$V_{CC} = MAX$,	V _I = 5.5 V					1			1	mΑ
IH	V _{CC} = MAX,	$V_1 = 2.4 \text{ V}$					40			40	μΑ
կլ_	$V_{CC} = MAX$,	V _[= 0.4 V					-1.6			- 1.6	mΑ
	V _{CC} = MAX,	See Note 2				30	43		30	50	mA

 $^{^{\}dagger}$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

NOTE 2: I_{CC} is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
tpLH	A n. P	Othor is out law	5 45 5		12	18	
tPH L	A or B	Other input low	CL = 15 pF,		39	50	ns
tPLH	A or B	Oshaniaansk bish	$R_{L} = 400 \Omega$,		14	22	ns
tpHL	wors	Other input high	See Note 3		42	55] ''

 $[\]mathbf{1}_{\mathsf{tpLH}}$ propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

трын propagation delay time, high-to-low-level output

SN54LS136, SN74LS136 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES WITH OPEN-COLLECTOR OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)													7 V
Input voltage													
Operating free-air temperature range:	SN54LS136		_		 _						-55°	'C to	125°C
	SN74LS136								_		. ()°C 1	to 70°C
Storage temperature range													150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	12	154LS1	36	SI	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	CIVIT
Supply voltage, V _{CC}	4,5	5	5.5	4.75	5	5.25	V
High-level output voltage, VOH			5.5			5.5	٧
Low-level output current, IOL			4			8	mΑ
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAGAMETED	7507.001	SI	V54LS1	36	SI				
PARAMETER	I EST CON	IDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
VIH High-level input voltage			2			2			٧
VIL Low-level input voltage					0.7			0.8	V
VIK Input clamp voltage	VCC = MIN.	I _I = -18 mA	1		-1.5			-1.5	٧
IOH High-level output current	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{OH} = 5.5 V			100			100	μА
VOL Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4	_	0.25	0.4	V
	VIL = VIL max	IOL = 8 mA					0.35	0.5	
I Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V			0.2			0.2	mΑ
IIH High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V			40			40	μА
ILL Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V	_		-0.8	l —		-0.8	mΑ
ICC Supply current	V _{CC} = MAX,	See Note 2	1	6.1	10		6.1	10	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡ Ail typical values are at V_{CC} = 5 V, T_{A} = 25°C.

NOTE 2: ICC is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TEST CO	NDITIONS	MIN	ТҮР	MAX	UNIT
tPLH tPLH	A or B	Other input low	0 - 15 5		18	30	ns
tРНL	A Of B	Other input low	C _L = 15 pF,		18	30	'''
^t PLH	A or B	Other input high	R _L = 2 kΩ, (See Note 3)		18	30	ns
^t PHL	7 0. 0	Other input high	(See Note 3)		18	30	11.3

¹tpLH propagation delay time, low-to-high-level output

tell propagation delay time, high-to-low-level output NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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